

Information Disclosure Statement

USSN 10/787,276

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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-4712 620052-7	U.S. SERIAL NO. 10/787,276
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANTS Peter D. BREWER	
	FILING DATE February 25, 2004	GROUP 2813 not yet assigned

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUB- CLASS	FILING DATE or 102(e) DATE IF APPROPRIATE

FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

TSP	Parker, E.H.C., <i>The Technology and Physics of Molecular Beam Epitaxy</i> , Plenum Press, New York, pp. 90-93, 138-139 (1985).
TSP	Tong, Q.-Y., et al., <i>Semiconductor Wafer Bonding, Science and Technology</i> , The Electrochemical Society Series, pp. 33-51 (1999).

EXAMINER	DATE CONSIDERED
	12/29/05

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 602. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.